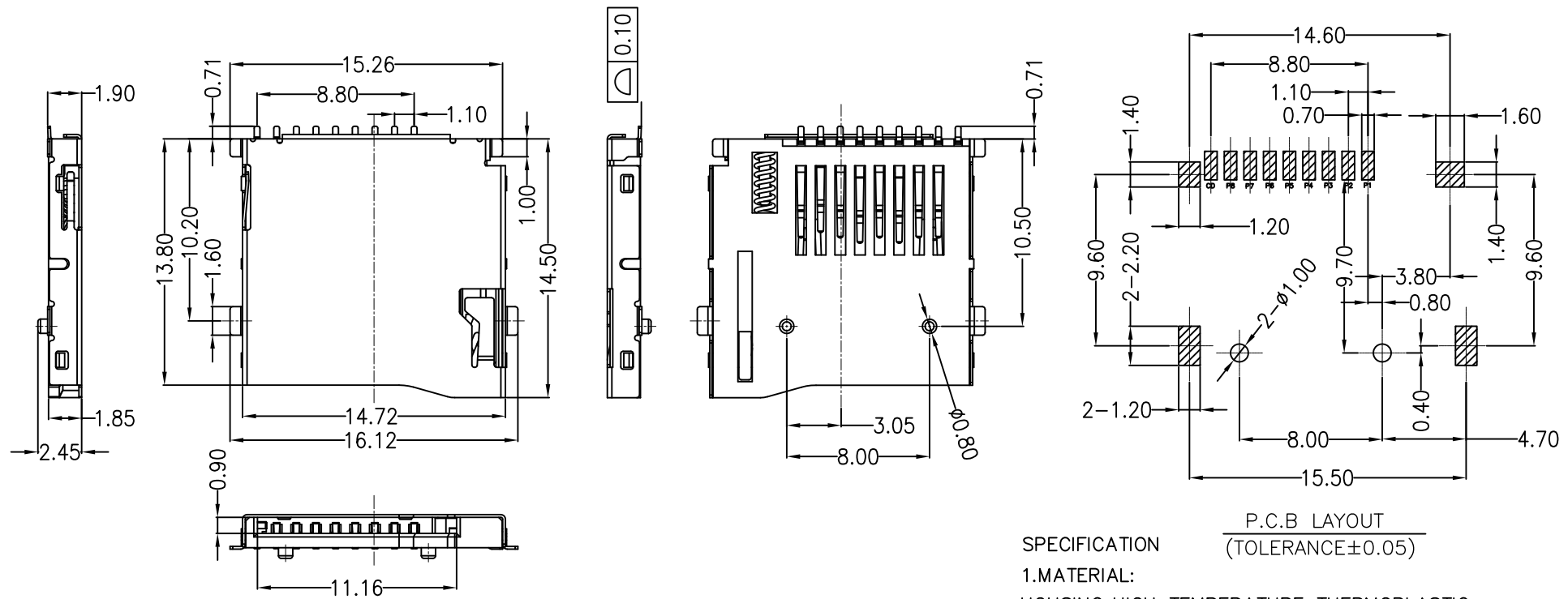
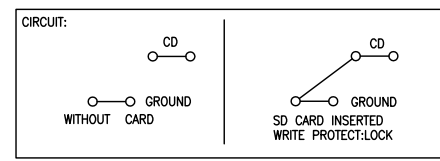


更改 REV	變更內容 MODIFICATION
A	ECXXXXX



P.C.B LAYOUT
(TOLERANCE±0.05)

PIN NO.	PIN ASSIGNMENT
1#	DAT2
2#	CD/DAT3 ²
3#	CMD
4#	VDD
5#	CLK
6#	VSS
7#	DAT0
8#	DAT1



SPECIFICATION

1.MATERIAL:
HOUSING:HIGH TEMPERATURE THERMOPLASTIC
UL 94V-0 , COLOR:BLACK
CONTACT: COPPER ALLOY
COVER: COPPER ALLOY
2.PLATING:
UNDERPLATE: NICKEL
CONTACT AREA: GOLD OVER NICKEL
SOLDER AREA: TIN PLATING OVER NICKEL(LEAD FREE).
3.COPLANARITY MUST BE WITHIN 0.10mm

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司
X± 0.50	X*± 5°	
X± 0.30	X*± 2°	
.XX± 0.20	.XX*± 1°	名 稱(TITLE) TF PUSH 卡座
單位(UNIT) mm	料 號(PART NO.) 7MSDP-F0-0032	圖 號(DWG NO.) 7MSDP-F0-0032
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)
SCALE 1:1		張 數 SHEET 1/1
PROJ.		更 改 REV A

